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August 11, 2000 and entitled, "Systems and Methods for Distributing Solder Paste Using a Tool Having a Solder Paste Aperture with a Non-Circular Cross-Sectional Shape."

A statement indicating that the above-identified Application is such a Divisional was provided on the earlier-submitted Application Transmittal Letter at the top of page 2.

Additionally, please amend the above-identified Application as follows:

IN THE SPECIFICATION:

At page 1, line 4, please insert the following paragraph:

-- CROSS REFERENCE TO RELATED APPLICATIONS

B1 This Application is a Divisional of U.S. Application Serial No. 09/636,360, filed August 11, 2000 and entitled, "Systems and Methods for Distributing Solder Paste Using a Tool Having a Solder Paste Aperture with a Non-Circular Cross-Sectional Shape." --

REMARKS

This second Preliminary Amendment includes a paragraph identifying the Application as a Divisional of an earlier-filed parent Application, as pointed out in the earlier-submitted Application Transmittal Letter at the top of page 2. No new matter has been added.

Furthermore, Applicant hereby provides an Application Data Sheet including, among other things, the domestic priority information for this Application.


Favorable handling of this Application is respectfully solicited.

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No fee is believed to be due with this material. If there is a fee occasioned by this material, including an extension fee, that is not covered by an enclosed check, please charge the fee or any fee deficiency to Deposit Account No. 50-0901.

If the enclosed papers or fees are considered incomplete or if there are any questions, the Patent Office is respectfully requested to contact the undersigned collect at (508) 366-9600, in Westborough, Massachusetts.

Respectfully submitted,



David E. Huang, Esq.
Attorney for Applicant
Registration No.: 39,229
CHAPIN & HUANG, L.L.C.
Westborough Office Park
1700 West Park Drive
Westborough, Massachusetts 01581
Telephone: (508) 366-9600
Facsimile: (508) 616-9805

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